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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	40MHz
Connectivity	EBI/EMI, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	36
Program Memory Size	72KB (72K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/sst89e516rd2-40-i-nje-t

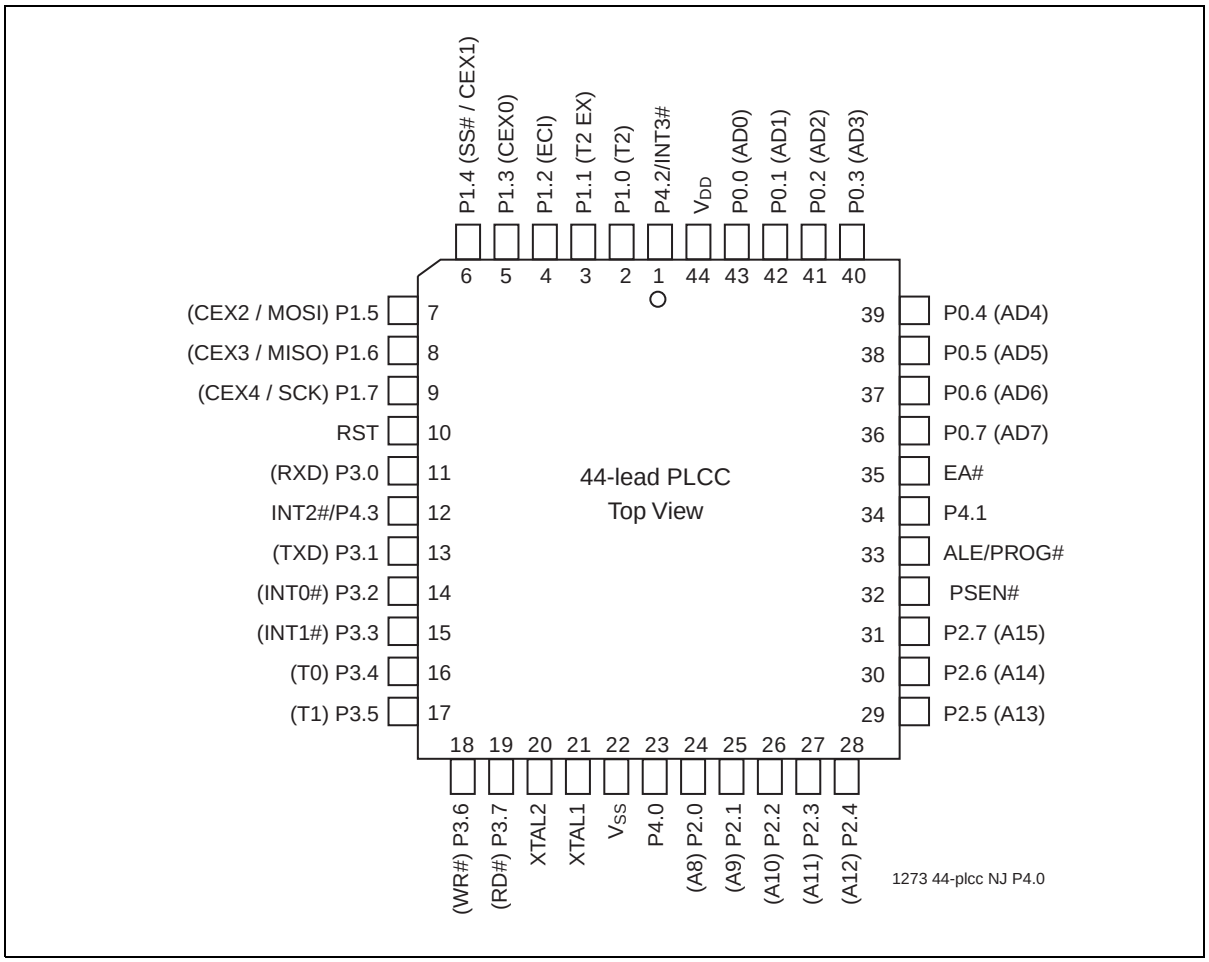

Figure 5: Pin Assignments for 44-lead PLCC

Interrupt Enable (IE)

Location	7	6	5	4	3	2	1	0	Reset Value
A8H	EA	EC	ET2	ES	ET1	EX1	ET0	EX0	00H

Symbol	Function
EA	Global Interrupt Enable. 0 = Disable 1 = Enable
EC	PCA Interrupt Enable.
ET2	Timer 2 Interrupt Enable.
ES	Serial Interrupt Enable.
ET1	Timer 1 Interrupt Enable.
EX1	External 1 Interrupt Enable.
ET0	Timer 0 Interrupt Enable.
EX0	External 0 Interrupt Enable.

Interrupt Enable A (IEA)

Location	7	6	5	4	3	2	1	0	Reset Value
E8H	-	-	-	-	EBO	-	-	-	xxxx0xxxb

Symbol	Function
EBO	Brown-out Interrupt Enable. 1 = Enable the interrupt 0 = Disable the interrupt

Watchdog Timer Data/Reload Register (WDTD)

Location	7	6	5	4	3	2	1	0	Reset Value
85H	Watchdog Timer Data/Reload								00H

Symbol	Function
WDTD	Initial/Reload value in Watchdog Timer. New value won't be effective until WDT is set.

PCA Timer/Counter Control Register[1] (CCON)

Location	7	6	5	4	3	2	1	0	Reset Value
D8H	CF	CR	-	CCF4	CCF3	CCF2	CCF1	CCF0	00x00000b

1. Bit addressable

Symbol	Function
CF	PCA Counter Overflow Flag Set by hardware when the counter rolls over. CF flags an interrupt if bit ECF in CMOD is set. CF may be set by either hardware or software, but can only cleared by software.
CR	PCA Counter Run control bit Set by software to turn the PCA counter on. Must be cleared by software to turn the PCA counter off.
-	Not implemented, reserved for future use. **Note:** User should not write '1's to reserved bits. The value read from a reserved bit is indeterminate.
CCF4	PCA Module 4 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF3	PCA Module 3 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF2	PCA Module 2 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF1	PCA Module 1 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.
CCF0	PCA Module 0 interrupt flag. Set by hardware when a match or capture occurs. Must be cleared by software.

SPI Data Register (SPDR)

Location	7	6	5	4	3	2	1	0	Reset Value
86H	SPDR[7:0]								00H

Power Control Register (PCON)

Location	7	6	5	4	3	2	1	0	Reset Value
87H	SMOD1	SMOD0	BOF	POF	GF1	GF0	PD	IDL	00010000b

Symbol	Function
SMOD1	Double Baud rate bit. If SMOD1 = 1, Timer 1 is used to generate the baud rate, and the serial port is used in modes 1, 2, and 3.
SMOD0	FE/SM0 Selection bit. 0: SCON[7] = SM0 1: SCON[7] = FE,
BOF	Brown-out detection status bit, this bit will not be affected by any other reset. BOF should be cleared by software. Power-on reset will also clear the BOF bit. 0: No brown-out. 1: Brown-out occurred
POF	Power-on reset status bit, this bit will not be affected by any other reset. POF should be cleared by software. 0: No Power-on reset. 1: Power-on reset occurred
GF1	General-purpose flag bit.
GF0	General-purpose flag bit.
PD	Power-down bit, this bit is cleared by hardware after exiting from power-down mode. 0: Power-down mode is not activated. 1: Activates Power-down mode.
IDL	Idle mode bit, this bit is cleared by hardware after exiting from idle mode. 0: Idle mode is not activated. 1: Activates idle mode.

Serial Port Control Register (SCON)

Location	7	6	5	4	3	2	1	0	Reset Value
98H	SM0/FE	SM1	SM2	REN	TB8	RB8	TI	RI	00000000b

Symbol **Function**

FE — Set SMOD0 = 1 to access FE bit.
0: No framing error
1: Framing Error. Set by receiver when an invalid stop bit is detected. This bit needs to be cleared by software.

SM0 — SMOD0 = 0 to access SM0 bit.
Serial Port Mode Bit 0

SM1 — Serial Port Mode Bit 1

SM0	SM1	Mode	Description	Baud Rate[1]
0	0	0	Shift Register	f_{OSC}/6 (6 clock mode) or f_{OSC}/12 (12 clock mode)
0	1	1	8-bit UART	Variable
1	0	2	9-bit UART	f_{OSC}/32 or f_{OSC}/16 (6 clock mode) or f_{OSC}/64 or f_{OSC}/32 (12 clock mode)
1	1	3	9-bit UART	Variable

1. f_{OSC} = oscillator frequency

SM2 — Enables the Automatic Address Recognition feature in Modes 2 or 3. If SM2 = 1 then RI will not be set unless the received 9th data bit (RB8) is 1, indicating an address, and the received byte is a given or broadcast address. In Mode 1, if SM2 = 1 then RI will not be activated unless a valid stop bit was received. In Mode 0, SM2 should be 0.

REN — Enables serial reception.
0: to disable reception.
1: to enable reception.

TB8 — The 9th data bit that will be transmitted in Modes 2 and 3. Set or clear by software as desired.

RB8 — In Modes 2 and 3, the 9th data bit that was received. In Mode 1, if SM2 = 0, RB8 is the stop bit that was received. In Mode 0, RB8 is not used.

TI — Transmit interrupt flag. Set by hardware at the end of the 8th bit time in Mode 0, or at the beginning of the stop bit in the other modes, in any serial transmission, Must be cleared by software.

RI — Receive interrupt flag. Set by hardware at the end of the8th bit time in Mode 0, or halfway through the stop bit time in the other modes, in any serial reception (except see SM2). Must be cleared by software.

Flash Memory Programming

The device internal flash memory can be programmed or erased using In-Application Programming (IAP) mode

Product Identification

The Read-ID command accesses the Signature Bytes that identify the device and the manufacturer as SST. External programmers primarily use these Signature Bytes in the selection of programming algorithms.

Table 12: Product Identification

	Address	Data
Manufacturer's ID	30H	BFH
Device ID		
SST89E516RD2/RD	31H	93H
SST89V516RD2/RD	31H	92H

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In-Application Programming Mode

The device offers either 72 KByte of in-application programmable flash memory. During in-application programming, the CPU of the microcontroller enters IAP mode. The two blocks of flash memory allow the CPU to execute user code from one block, while the other is being erased or reprogrammed concurrently. The CPU may also fetch code from an external memory while all internal flash is being reprogrammed. The mailbox registers (SFST, SFCM, SFAL, SFAH, SFDT and SFCF) located in the special function register (SFR), control and monitor the device's erase and program process.

Table 14 outline the commands and their associated mailbox register settings.

In-Application Programming Mode Clock Source

During IAP mode, both the CPU core and the flash controller unit are driven off the external clock. However, an internal oscillator will provide timing references for Program and Erase operations. The internal oscillator is only turned on when required, and is turned off as soon as the flash operation is completed.

Memory Bank Selection for In-Application Programming Mode

With the addressing range limited to 16 bit, only 64 KByte of program address space is "visible" at any one time. As shown in Table 13, the bank selection (the configuration of EA# and SFCF[1:0]), allows Block 1 memory to be overlaid on the lowest 8 KByte of Block 0 memory, making Block 1 reachable. The same concept is employed to allow both Block 0 and Block 1 flash to be accessible to IAP operations. Code from a block that is not visible may not be used as a source to program another address. However, a block that is not "visible" may be programmed by code from the other block through mailbox registers.

The device allows IAP code in one block of memory to program the other block of memory, but may not program any location in the same block. If an IAP operation originates physically from Block 0, the target of this operation is implicitly defined to be in Block 1. If the IAP operation originates physically from

Byte-Verify

The Byte-Verify command allows the user to verify that the device has correctly performed an Erase or Program command. Byte-Verify command returns the data byte in SFDT if the command is successful. The user is required to check that the previous flash operation has fully completed before issuing a Byte-Verify. Byte-Verify command execution time is short enough that there is no need to poll for command completion and no interrupt is generated.

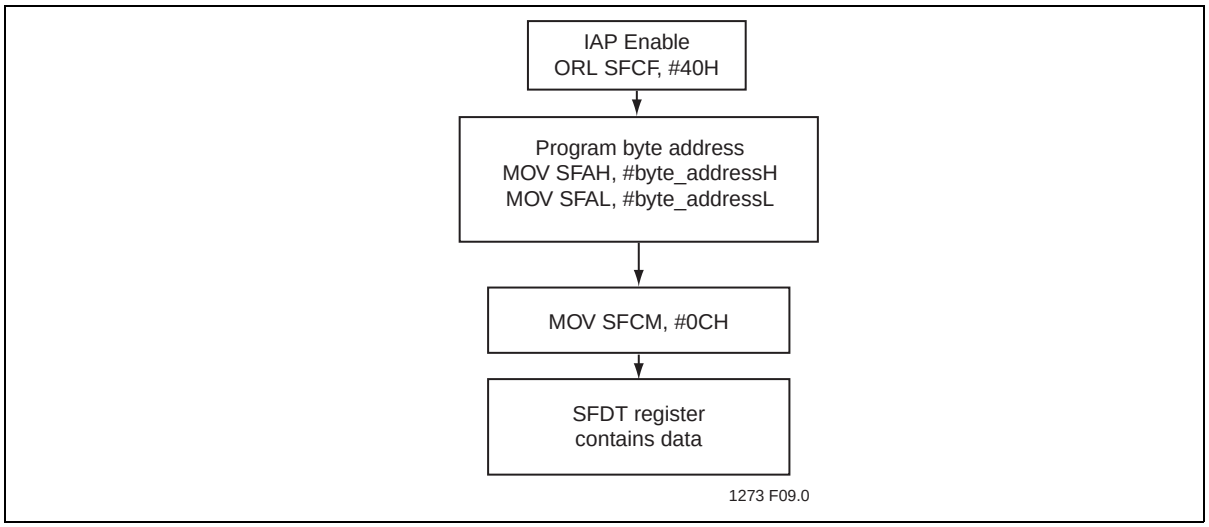

Figure 13: Byte Verify

Prog-SB3, Prog-SB2, Prog-SB1

Prog-SB3, Prog-SB2, Prog-SB1 commands are used to program the security bits (see Table 25). Completion of any of these commands, the security options will be updated immediately.

Security bits previously in un-programmed state can be programmed by these commands. Prog-SB3, Prog-SB2 and Prog-SB1 commands should only reside in Block 1 or external code memory.

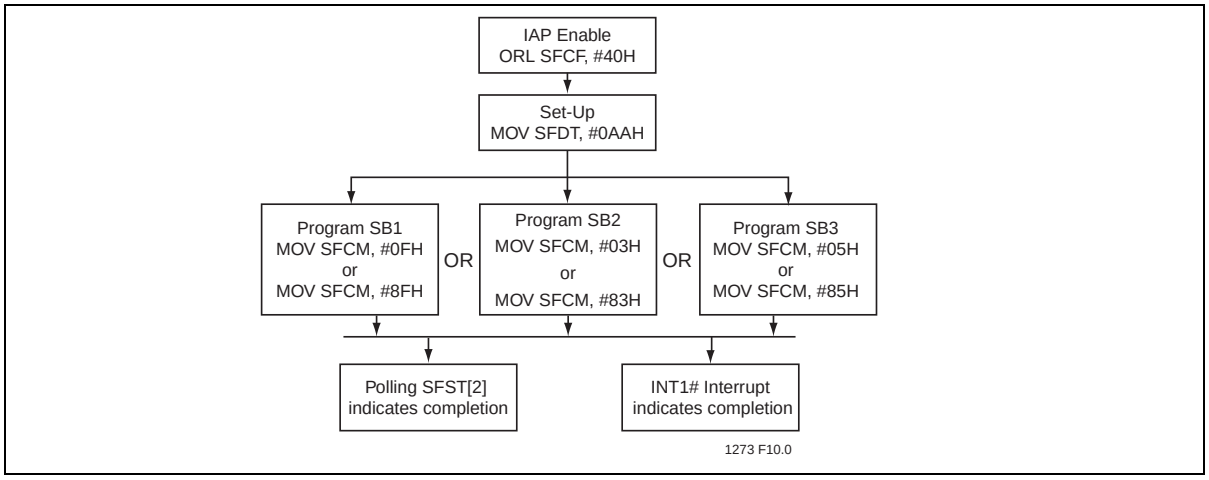

Figure 14: Prog-SB3, Prog-SB2, Prog-SB1

Prog-SC0

Prog-SC0 command is used to program the SC0 bit. This command only changes the SC0 bit and has no effect on BSEL bit until after a reset cycle.

SC0 bit previously in un-programmed state can be programmed by this command. The Prog-SC0 command should reside only in Block 1 or external code memory.

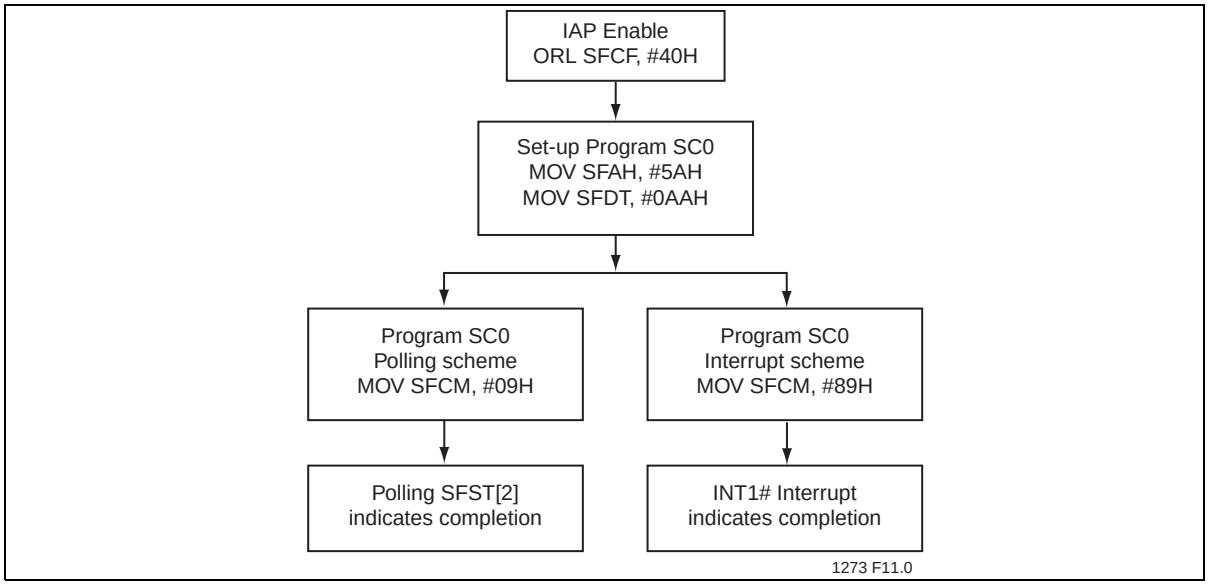

Figure 15: Prog-SC0

Enable-Clock-Double

Enable-Clock-Double command is used to make the MCU run at 6 clocks per machine cycle. The standard (default) is 12 clocks per machine cycle (i.e. clock double command disabled).

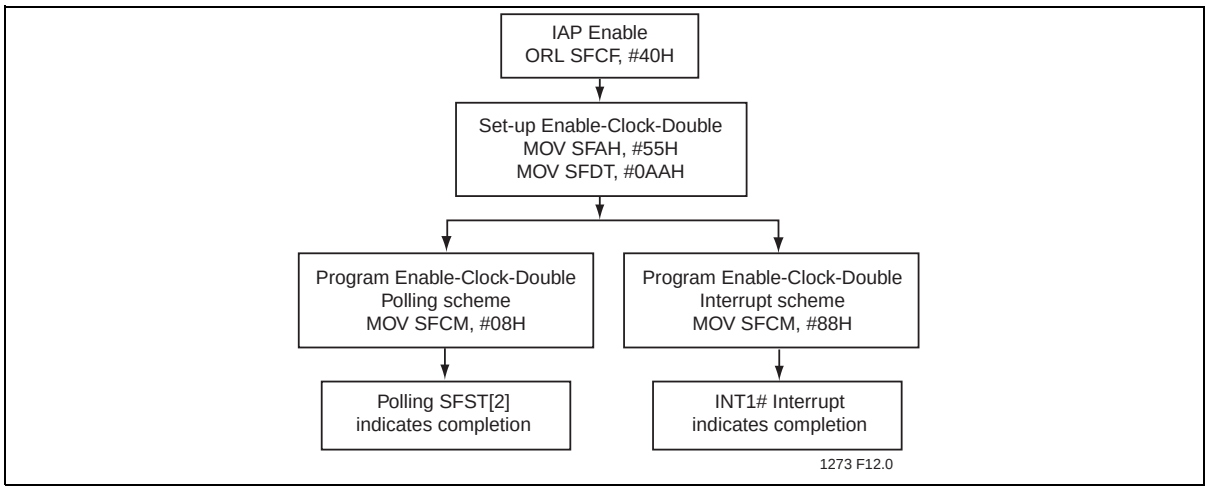

Figure 16: Enable-Clock-Double

There are no IAP counterparts for the external host commands Select-Block0 and Select-Block1.

Serial I/O

Full-Duplex, Enhanced UART

The device serial I/O port is a full-duplex port that allows data to be transmitted and received simultaneously in hardware by the transmit and receive registers, respectively, while the software is performing other tasks. The transmit and receive registers are both located in the Serial Data Buffer (SBUF) special function register. Writing to the SBUF register loads the transmit register, and reading from the SBUF register obtains the contents of the receive register.

The UART has four modes of operation which are selected by the Serial Port Mode Specifier (SM0 and SM1) bits of the Serial Port Control (SCON) special function register. In all four modes, transmission is initiated by any instruction that uses the SBUF register as a destination register. Reception is initiated in mode 0 when the Receive Interrupt (RI) flag bit of the Serial Port Control (SCON) SFR is cleared and the Reception Enable/ Disable (REN) bit of the SCON register is set. Reception is initiated in the other modes by the incoming start bit if the REN bit of the SCON register is set.

Framing Error Detection

Framing Error Detection is a feature, which allows the receiving controller to check for valid stop bits in modes 1, 2, or 3. Missing stops bits can be caused by noise in serial lines or from simultaneous transmission by two CPUs.

Framing Error Detection is selected by going to the PCON register and changing SMOD0 = 1 (see Figure 17). If a stop bit is missing, the Framing Error bit (FE) will be set. Software may examine the FE bit after each reception to check for data errors. After the FE bit has been set, it can only be cleared by software. Valid stop bits do not clear FE. When FE is enabled, RI rises on the stop bit, instead of the last data bit (see Figure 18 and Figure 19).

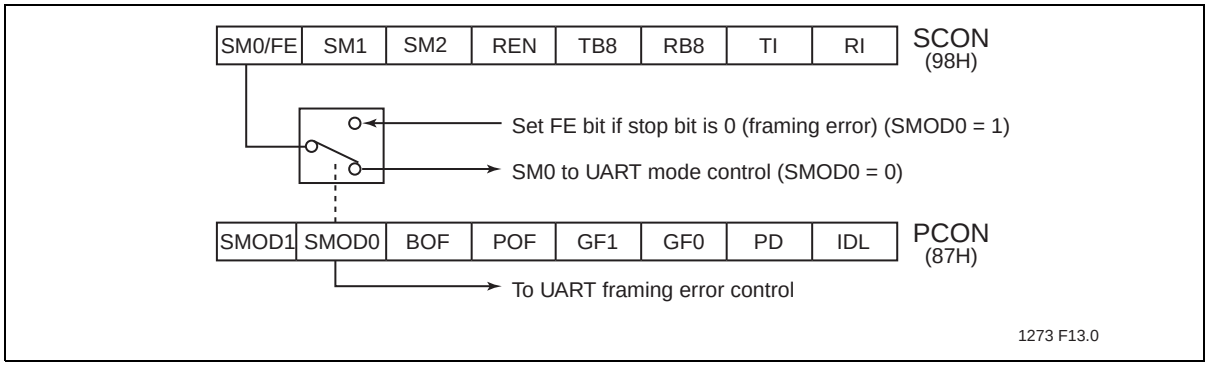

Figure 17: Framing Error Block Diagram

an interrupt will be generated if the ECF bit in the CMOD register is set. The CF bit can only be cleared by software. Each module has its own timer interrupt or capture interrupt flag (CCF0 for module 0, CCF4 for module 4, etc.). They are set when either a match or capture occurs. These flags can only be cleared by software. (See “PCA Timer/Counter Control Register (CCON)” on page 27.)

Compare/Capture Modules

Each PCA module has an associated SFR with it. These registers are: CCAPM0 for module 0, CCAPM1 for module 1, etc. Refer to “PCA Compare/Capture Module Mode Register (CCAPMn)” on page 29 for details. The registers each contain 7 bits which are used to control the mode each module will operate in. The ECCF bit (CCAPMn.0 where n = 0, 1, 2, 3, or 4 depending on module) will enable the CCF flag in the CCON SFR to generate an interrupt when a match or compare occurs. PWM (CCAPMn.1) enables the pulse width modulation mode. The TOG bit (CCAPMn.2) when set, causes the CEX output associated with the module to toggle when there is a match between the PCA counter and the module’s capture/compare register. When there is a match between the PCA counter and the module’s capture/compare register, the MATn (CCAPMn.3) and the CCFn bit in the CCON register to be set.

Bits CAPN (CCAPMn.4) and CAPP (CCAPMn.5) determine whether the capture input will be active on a positive edge or negative edge. The CAPN bit enables the negative edge that a capture input will be active on, and the CAPP bit enables the positive edge. When both bits are set, both edges will be enabled and a capture will occur for either transition. The last bit in the register ECOM (CCAPMn.6) when set, enables the comparator function. Table 22 shows the CCAPMn settings for the various PCA functions.

There are two additional register associated with each of the PCA modules: CCAPnH and CCAPnL. They are registers that hold the 16-bit count value when a capture occurs or a compare occurs. When a module is used in PWM mode, these registers are used to control the duty cycle of the output. See Figure 24.

Table 21: PCA High and Low Register Compare/Capture Modules

Symbol	Description	Direct Address	Bit Address, Symbol, or Alternative Port Function MSB LSB	RESET Value
CCAP0H	PCA Module 0 Compare/Capture Registers	FAH	CCAP0H[7:0]	00H
CCAP0L		EAH	CCAP0L[7:0]	00H
CCAP1H	PCA Module 1 Compare/Capture Registers	FBH	CCAP1H[7:0]	00H
CCAP1L		EBH	CCAP1L[7:0]	00H
CCAP2H	PCA Module 2 Compare/Capture Registers	FCH	CCAP2H[7:0]	00H
CCAP2L		ECH	CCAP2L[7:0]	00H
CCAP3H	PCA Module 3 Compare/Capture Registers	FDH	CCAP3H[7:0]	00H
CCAP3L		EDH	CCAP3L[7:0]	00H
CCAP4H	PCA Module 4 Compare/Capture Registers	FEH	CCAP4H[7:0]	00H
CCAP4L		EEH	CCAP4L[7:0]	00H

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Table 22: PCA Module Modes

Without Interrupt enabled								
-[1]	ECOMy[2]	CAPPy[2]	CAPNy[2]	MATy[2]	TOGy[2]	PWMy[2]	ECCFy[2]	Module Code
-	0	0	0	0	0	0	0	No Operation
-	0	1	0	0	0	0	0	16-bit capture on positive-edge trigger at CEX[4:0]
-	0	0	1	0	0	0	0	16-bit capture on negative-edge trigger at CEX[4:0]
-	0	1	1	0	0	0	0	16-bit capture on positive/negative-edge trigger at CEX[4:0]
-	1	0	0	1	0	0	0	Compare: software timer
-	1	0	0	1	1	0	0	Compare: high-speed output
-	1	0	0	0	0	1	0	Compare: 8-bit PWM
-	1	0	0	1	0 or 1[3]	0	0	Compare: PCA WDT (CCAPM4 only)[4]

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1. User should not write ‘1’s to reserved bits. The value read from a reserved bit is indeterminate.
2. y = 0, 1, 2, 3, 4
3. A 0 disables toggle function. A 1 enables toggle function on CEX[4:0] pin.
4. For PCA WDT mode, also set the WDTE bit in the CMOD register to enable the reset output signal.

Table 23: PCA Module Modes

With Interrupt enabled								
-[1]	ECOMy[2]	CAPPy[2]	CAPNy[2]	MATy[2]	TOGy[2]	PWMy[2]	ECCFy[2]	Module Code
-	0	1	0	0	0	0	1	16-bit capture on positive-edge trigger at CEX[4:0]
-	0	0	1	0	0	0	1	16-bit capture on negative-edge trigger at CEX[4:0]
-	0	1	1	0	0	0	1	16-bit capture on positive/negative-edge trigger at CEX[4:0]
-	1	0	0	1	0	0	1	Compare: software timer
-	1	0	0	1	1	0	1	Compare: high-speed output
-	1	0	0	0	0	1	X[3]	Compare: 8-bit PWM
-	1	0	0	1	0 or 1[4]	0	X[5]	Compare: PCA WDT (CCAPM4 only)[6]

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1. User should not write ‘1’s to reserved bits. The value read from a reserved bit is indeterminate.
2. y = 0, 1, 2, 3, 4
3. No PCA interrupt is needed to generate the PWM.
4. A 0 disables toggle function. A 1 enables toggle function on CEX[4:0] pin.
5. Enabling an interrupt for the Watchdog Timer would defeat the purpose of the Watchdog Timer.
6. For PCA WDT mode, also set the WDTE bit in the CMOD register to enable the reset output signal.

```
CLR EA; Hold off interrupts

MOVCCAP4L, #00; Next compare value is within

MOVCCAP4H, CH; 65,535 counts of the
; current PCA

SETBEA; timer value

RET

;===========================================
```

This routine should not be part of an interrupt service routine. If the program counter goes astray and gets stuck in an infinite loop, interrupts will still be serviced and the watchdog will keep getting reset. Thus, the purpose of the watchdog would be defeated. Instead, call this subroutine from the main program of the PCA timer.

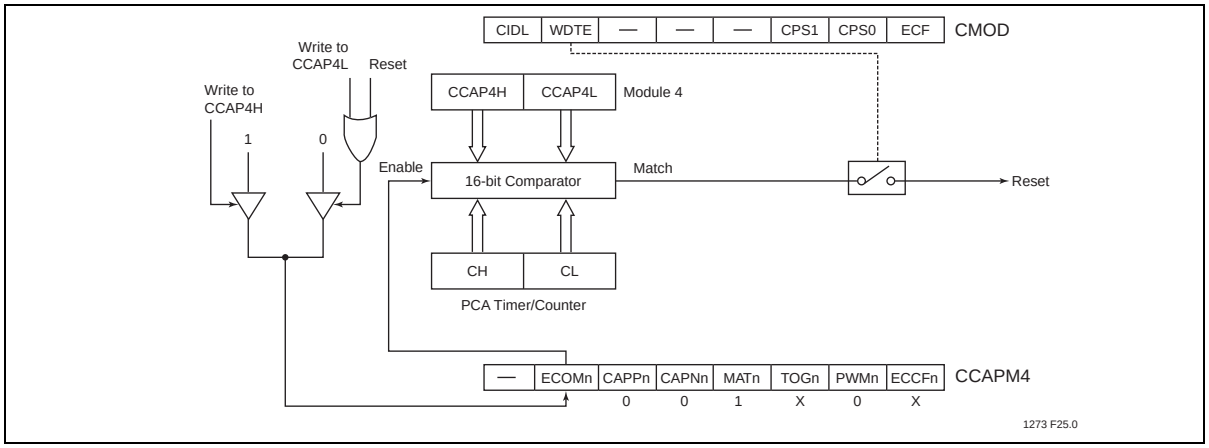

Figure 29: PCA Watchdog Timer (Module 4 only)

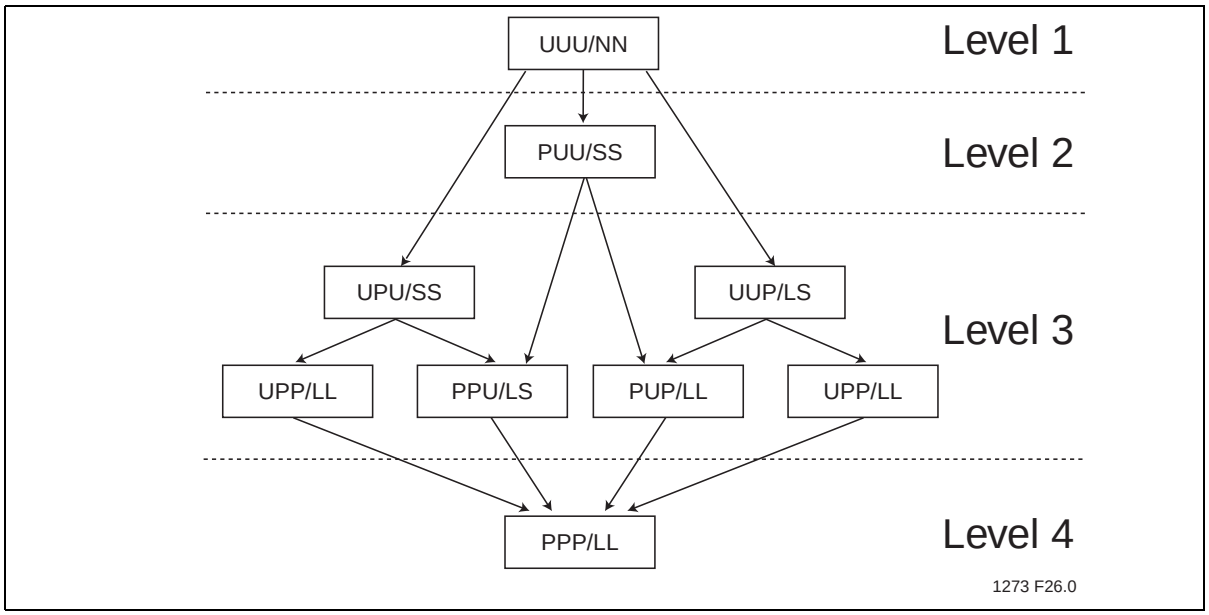

Figure 30: Security Lock Levels

Note: P = Programmed (Bit logic state = 0), U = Unprogrammed (Bit logic state = 1), N = Not Locked, L = Hard locked, S = Soft locked

Table 25: Security Lock Options

Level	Security Lock Bits[1,2]				Security Status of:		Security Type
	SFST[7:5]	SB1	SB2[1]	SB3[1]	Block 1	Block 0	
1	000	U	U	U	Unlock	Unlock	No Security Features are Enabled.
2	100	P	U	U	SoftLock	SoftLock	MOVC instructions executed from external program memory are disabled from fetching code bytes from internal memory, EA# is sampled and latched on Reset, and further programming of the flash is disabled.
3	011 101	U P	P U	P P	Hard Lock	Hard Lock	Level 2 plus Verify disabled, both blocks locked.
	010	U	P	U	SoftLock	SoftLock	Level 2 plus Verify disabled. Code in Block 1 may program Block 0 and vice versa.
	110 001	P U	P U	U P	Hard Lock	SoftLock	Level 2 plus Verify disabled. Code in Block 1 may program Block 0.
4	111	P	P	P	Hard Lock	Hard Lock	Same as Level 3 hard lock/hard lock, but MCU will start code execution from the internal memory regardless of EA#.

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1. P = Programmed (Bit logic state = 0), U = Unprogrammed (Bit logic state = 1).
2. SFST[7:5] = Security Lock Status Bits (SB1_i, SB2_i, SB3_i)

Read Operation Under Lock Condition

The status of security bits SB1, SB2, and SB3 can be read when the read command is disabled by security lock. There are three ways to read the status.

1. External host mode: Read-back = 00H (locked)
2. IAP command: Read-back = previous SFDT data
3. MOVC: Read-back = FFH (blank)

Table 26: Security Lock Access Table

Level	SFST[7:5]	Source Address[1]	Target Address[2]	Byte-Verify Allowed		MOVC Allowed
				External Host[3]	IAP	516RDx
4	111b (hard lock on both blocks)	Block 0/1	Block 0/1	N	N	Y
			External	N/A	N/A	N
		External	Block 0/1	N	N	N
			External	N/A	N/A	N
3	011b/101b (hard lock on both blocks)	Block 0/1	Block 0/1	N	N	Y
			External	N/A	N/A	N
		External	Block 0/1	N	N	N
			External	N/A	N/A	Y
	001b/110b (Block 0 = SoftLock, Block 1 = hard lock)	Block 0	Block 0	N	N	Y
			Block 1	N	N	N
			External	N/A	N/A	N
		Block 1	Block 0	N	Y	Y
			Block 1	N	N	Y
			External	N/A	N/A	N
		External	Block 0/1	N	N	N
			External	N/A	N/A	Y
	010b (SoftLock on both blocks)	Block 0	Block 0	N	N	Y
			Block 1	N	Y	Y
			External	N/A	N/A	N
		Block 1	Block 0	N	Y	Y
			Block 1	N	N	Y
			External	N/A	N/A	N
		External	Block 0/1	N	N	N
			External	N/A	N/A	Y
2	100b (SoftLock on both blocks)	Block 0	Block 0	Y	N	Y
			Block 1	Y	Y	Y
			External	N/A	N/A	N
		Block 1	Block 0	Y	Y	Y
			Block 1	Y	N	Y
			External	N/A	N/A	N
		External	Block 0/1	Y	N	N
			External	N/A	N/A	Y

Software Reset

The software reset is executed by changing SFCF[1] (SWR) from “0” to “1”. A software reset will reset the program counter to address 0000H. All SFR registers will be set to their reset values, except SFCF[1] (SWR), WDTC[2] (WDTS), and RAM data will not be altered.

Brown-out Detection Reset

The device includes a brown-out detection circuit to protect the system from severed supplied voltage V_{DD} fluctuations. SST89E516RDx internal brown-out detection threshold is 3.85V, SST89V516RDx brown-out detection threshold is 2.35V. For brown-out voltage parameters, please refer to Table 36.

When V_{DD} drops below this voltage threshold, the brown-out detector triggers the circuit to generate a brown-out interrupt but the CPU still runs until the supplied voltage returns to the brown-out detection voltage V_{BOD}. The default operation for a brown-out detection is to cause a processor reset.

V_{DD} must stay below V_{BOD} at least four oscillator clock periods before the brown-out detection circuit will respond.

Brown-out interrupt can be enabled by setting the EBO bit in IEA register (address E8H, bit 3). If EBO bit is set and a brown-out condition occurs, a brown-out interrupt will be generated to execute the program at location 004BH. It is required that the EBO bit be cleared by software after the brown-out interrupt is serviced. Clearing EBO bit when the brown-out condition is active will properly reset the device. If brown-out interrupt is not enabled, a brown-out condition will reset the program to resume execution at location 0000H.

Table 28: Power Saving Modes

Mode	Initiated by	State of MCU	Exited by
Idle Mode	Software (Set IDL bit in PCON) MOV PCON, #01H;	CLK is running. Interrupts, serial port and timers/counters are active. Program Counter is stopped. ALE and PSEN# signals at a HIGH level during Idle. All registers remain unchanged.	Enabled interrupt or hardware reset. Start of interrupt clears IDL bit and exits idle mode, after the ISR RETI instruction, program resumes execution beginning at the instruction following the one that invoked idle mode. A user could consider placing two or three NOP instructions after the instruction that invokes idle mode to eliminate any problems. A hardware reset restarts the device similar to a power-on reset.
Power-down Mode	Software (Set PD bit in PCON) MOV PCON, #02H;	CLK is stopped. On-chip SRAM and SFR data is maintained. ALE and PSEN# signals at a LOW level during power -down. External Interrupts are only active for level sensitive interrupts, if enabled.	Enabled external level sensitive interrupt or hardware reset. Start of interrupt clears PD bit and exits power-down mode, after the ISR RETI instruction program resumes execution beginning at the instruction following the one that invoked power-down mode. A user could consider placing two or three NOP instructions after the instruction that invokes power-down mode to eliminate any problems. A hardware reset restarts the device similar to a power-on reset.

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System Clock and Clock Options

Clock Input Options and Recommended Capacitor Values for Oscillator

Shown in Figure 33 are the input and output of an internal inverting amplifier (XTAL1, XTAL2), which can be configured for use as an on-chip oscillator.

When driving the device from an external clock source, XTAL2 should be left disconnected and XTAL1 should be driven.

At start-up, the external oscillator may encounter a higher capacitive load at XTAL1 due to interaction between the amplifier and its feedback capacitance. However, the capacitance will not exceed 15 pF once the external signal meets the V_{IL} and V_{IH} specifications.

Crystal manufacturer, supply voltage, and other factors may cause circuit performance to differ from one application to another. C1 and C2 should be adjusted appropriately for each design. Table 29, shows the typical values for C1 and C2 vs. crystal type for various frequencies

Table 29: Recommended Values for C1 and C2 by Crystal Type

Crystal	C1 = C2
Quartz	20-30pF
Ceramic	40-50pF

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More specific information about on-chip oscillator design can be found in the ***FlashFlex Oscillator Circuit Design Considerations*** application note.

Clock Doubling Option

By default, the device runs at 12 clocks per machine cycle (x1 mode). The device has a clock doubling option to speed up to 6 clocks per machine cycle. Please refer to Table 30 for detail.

Clock double mode can be enabled either via the external host mode or the IAP mode. Please refer to Table 14 for the IAP mode enabling commands (When set, the EDC# bit in SFST register will indicate 6 clock mode.).

The clock double mode is only for doubling the internal system clock and the internal flash memory, i.e. EA#=1. To access the external memory and the peripheral devices, careful consideration must be taken. Also note that the crystal output (XTAL2) will not be doubled.

DC Electrical Characteristics

Table 36: DC Electrical Characteristics for SST89E516RDx
T_A = -40°C to +85°C; V_{DD} = 4.5-5.5V; V_{SS} = 0V

Symbol	Parameter	Test Conditions	Min	Max	Units
V_{IL}	Input Low Voltage	4.5 < V_{DD} < 5.5	-0.5	0.2V_{DD} - 0.1	V
V_{IH}	Input High Voltage	4.5 < V_{DD} < 5.5	0.2V_{DD} + 0.9	V_{DD} + 0.5	V
V_{IH1}	Input High Voltage (XTAL1, RST)	4.5 < V_{DD} < 5.5	0.7V_{DD}	V_{DD} + 0.5	V
V_{OL}	Output Low Voltage (Ports 1.5, 1.6, 1.7)	V_{DD} = 4.5V			
		I_{OL} = 16mA		1.0	V
V_{OL}	Output Low Voltage (Ports 1, 2, 3)[1]	V_{DD} = 4.5V			
		I_{OL} = 100µA[2]		0.3	V
		I_{OL} = 1.6mA[2]		0.45	V
		I_{OL} = 3.5mA[2]		1.0	V
V_{OL1}	Output Low Voltage (Port 0, ALE, PSEN#)[1,3]	V_{DD} = 4.5V			
		I_{OL} = 200µA[2]		0.3	V
		I_{OL} = 3.2mA[2]		0.45	V
V_{OH}	Output High Voltage (Ports 1, 2, 3, ALE, PSEN#)[4]	V_{DD} = 4.5V			
		I_{OH} = -10µA	V_{DD} - 0.3		V
		I_{OH} = -30µA	V_{DD} - 0.7		V
		I_{OH} = -60µA	V_{DD} - 1.5		V
V_{OH1}	Output High Voltage (Port 0 in External Bus Mode)[4]	V_{DD} = 4.5V			
		I_{OH} = -200µA	V_{DD} - 0.3		V
		I_{OH} = -3.2mA	V_{DD} - 0.7		V
V_{BOD}	Brown-out Detection Voltage		3.85	4.15	V
I_{IL}	Logical 0 Input Current (Ports 1, 2, 3)	V_{IN} = 0.4V		-75	µA
I_{TL}	Logical 1-to-0 Transition Current (Ports 1, 2, 3)[5]	V_{IN} = 2V		-650	µA
I_{LI}	Input Leakage Current (Port 0)	0.45 < V_{IN} < V_{DD}-0.3		±10	µA
R_{RST}	RST Pull-down Resistor		40	225	KΩ
C_{IO}	Pin Capacitance[6]	@ 1 MHz, 25°C		15	pF
I_{DD}	Power Supply Current IAP Mode @ 40 MHz			88	mA
	Active Mode @ 40 MHz			50	mA
	Idle Mode @ 40 MHz			42	mA
	Power-down Mode (min. V_{DD} = 2V)	T_A = 0°C to +70°C		80	µA
		T_A = -40°C to +85°C		90	µA

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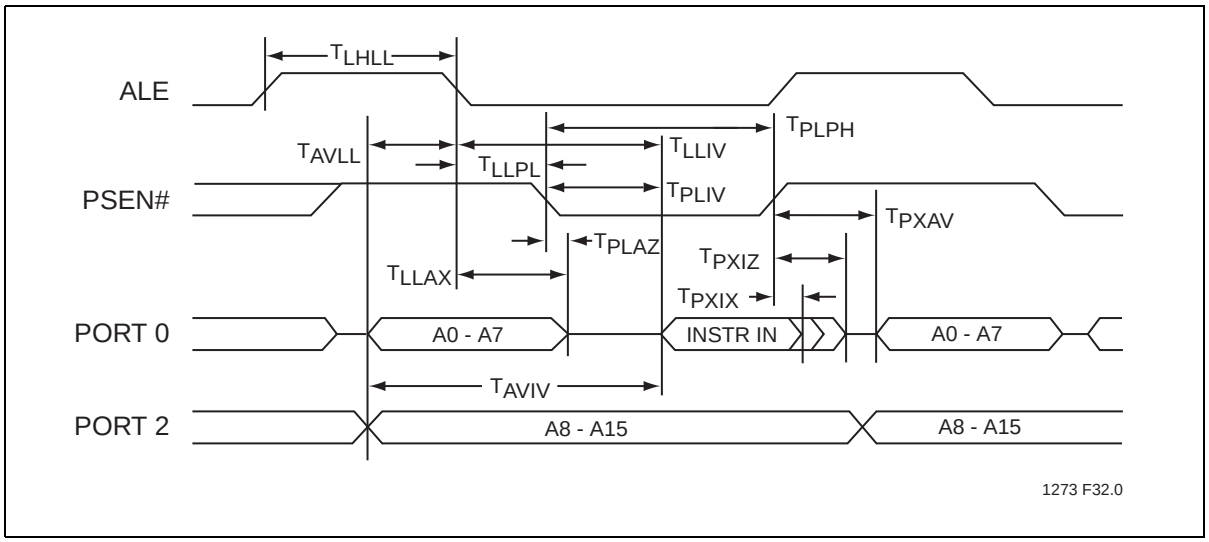

Figure 36: External Program Memory Read Cycle

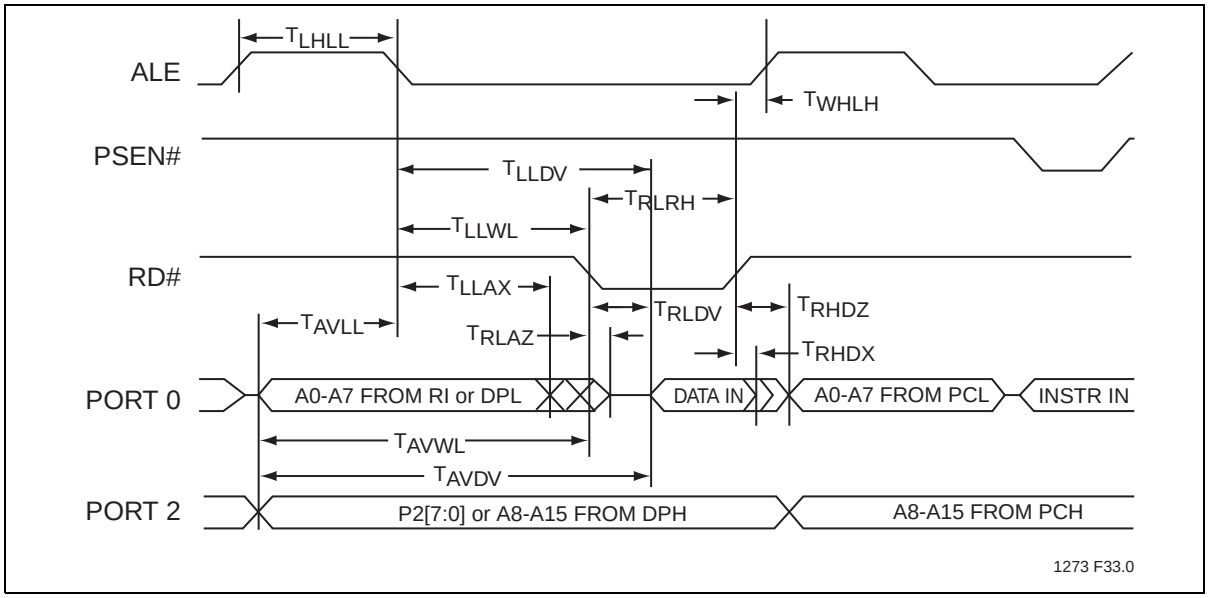

Figure 37: External Data Memory Read Cycle

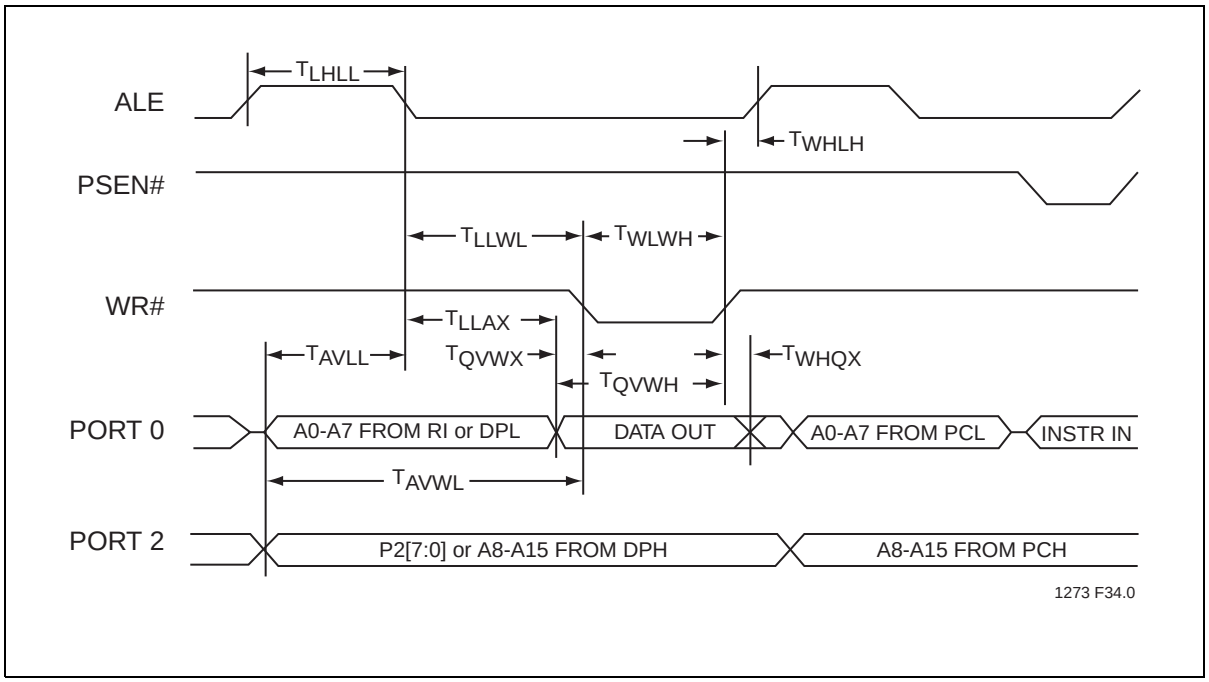

Figure 38: External Data Memory Write Cycle

Table 39: External Clock Drive

Symbol	Parameter	Oscillator						Units
		12MHz		40MHz		Variable		
		Min	Max	Min	Max	Min	Max	
$1/T_{CLCL}$	Oscillator Frequency					0	40	MHz
T_{CLCL}		83		25				ns
T_{CHCX}	High Time			8.75		$0.35T_{CLCL}$	$0.65T_{CLCL}$	ns
T_{CLCX}	Low Time			8.75		$0.35T_{CLCL}$	$0.65T_{CLCL}$	ns
T_{CLCH}	Rise Time		20		10			ns
T_{CHCL}	Fall Time		20		10			ns

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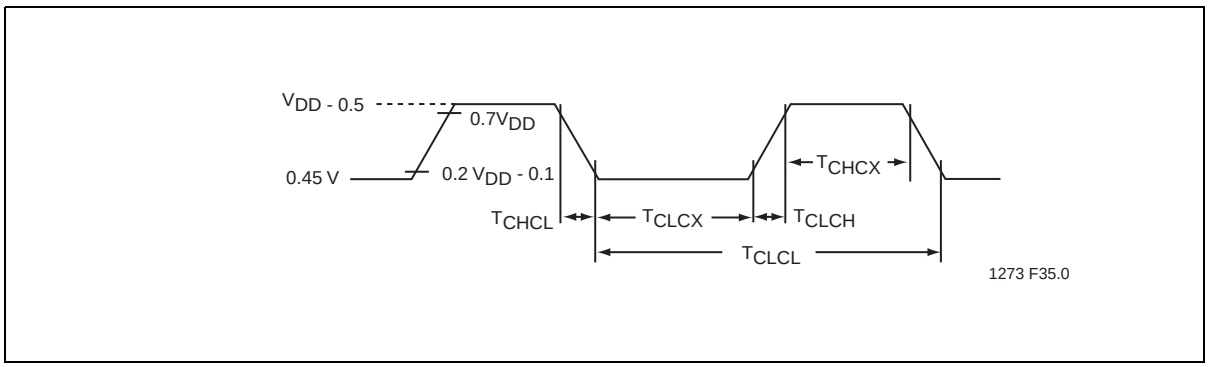

Figure 39: External Clock Drive Waveform